

Product data sheet

1. Product profile

1.1 General description

Passivated high voltage, high commutation triac in a full pack, plastic package. This triac is intended for use in motor control circuits where high blocking voltage, high static and dynamic dV/dt as well as high dl/dt can occur. This device will commutate the full rated RMS current at the maximum rated junction temperature, without the aid of a snubber.

1.2 Features



2. Pinning information

Table 1:	Pinning		
Pin	Description	Simplified outline	Symbol
1	main terminal 1 (T1)		
2	main terminal 2 (T2)	mb	T2-T1
3	gate (G)		`G sym051
mb	mounting base; isolated		

SOT186A (3-lead TO-220F)



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3. Ordering information

Table 2: Ordering information							
Type number	Package						
	Name	Description	Version				
BTA208X-1000C	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 'full pack'	SOT186A				

4. Limiting values

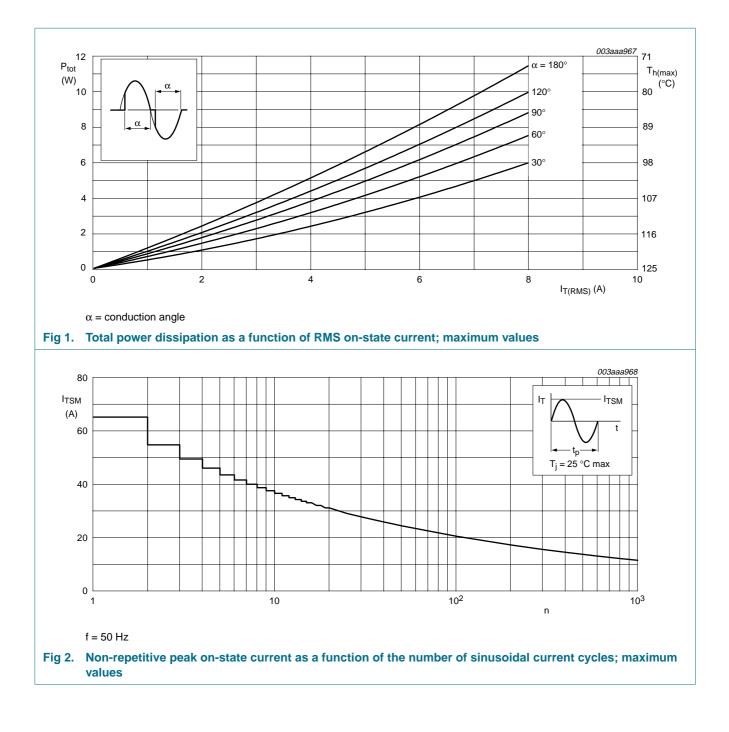
Table 3:Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	1000	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_h \le 73 \text{ °C}$; see Figure 4 and 5	-	8	A
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior}$ to surge; see <u>Figure 2</u> and <u>3</u>			
		t = 20 ms	-	65	А
		t = 16.7 ms	-	71	А
l²t	I ² t for fusing	t = 10 ms	-	21	A ² s
dl _T /dt	rate of rise of on-state current	$I_{TM} = 12 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	100	A/μs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	+150	°C
T _i	junction temperature		-	125	°C

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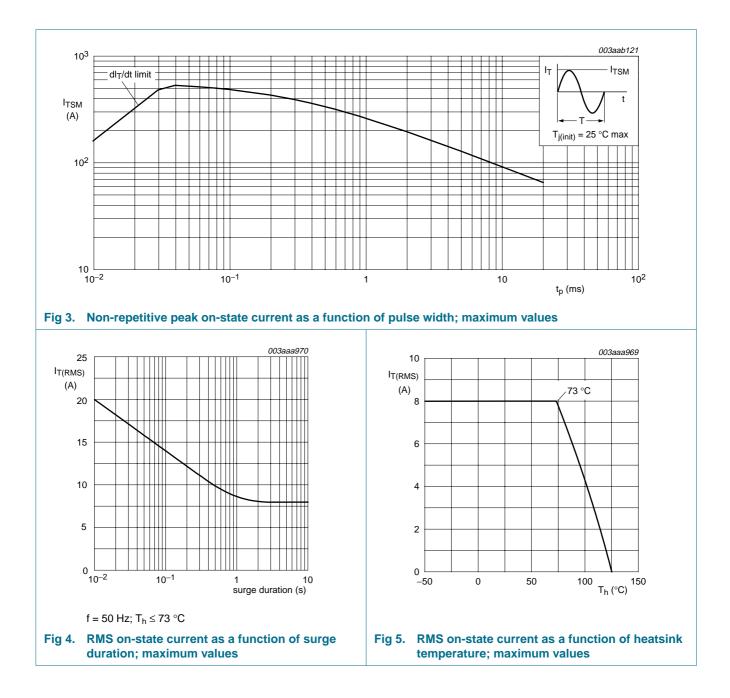
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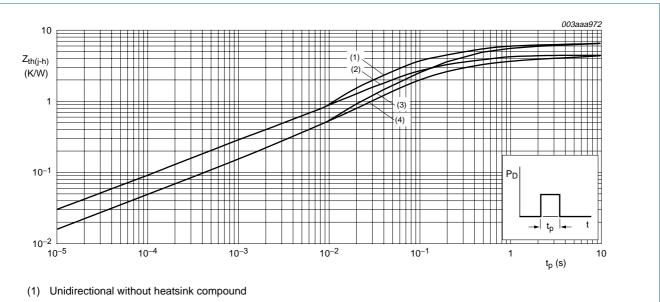
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5. Thermal characteristics

Table 4:	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to heatsink	see Figure 6	<u>[1</u>	1 -	-	4.5	K/W
		see Figure 6	[2	<u>-</u>	-	6.5	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air		-	55	-	K/W

[1] Full or half cycle; with heatsink compound.

[2] Full or half cycle; without heatsink compound.



(2) Unidirectional with heatsink compound

(3) Bidirectional without heatsink compound

(4) Bidirectional with heatsink compound

Fig 6. Transient thermal impedance from junction to heatsink as a function of pulse width

6. Isolation characteristics

Table 5: Isolation limiting values and characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(rms)}	RMS isolation voltage	f = 50 Hz to 60 Hz; sinusoidal waveform; RH \leq 65 %; clean and dust free; from all three terminals to external heatsink	-	-	2500	V
C _{isol}	isolation capacitance	f = 1 MHz; from pin 2 to external heatsink	-	10	-	pF

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Characteristics 7.

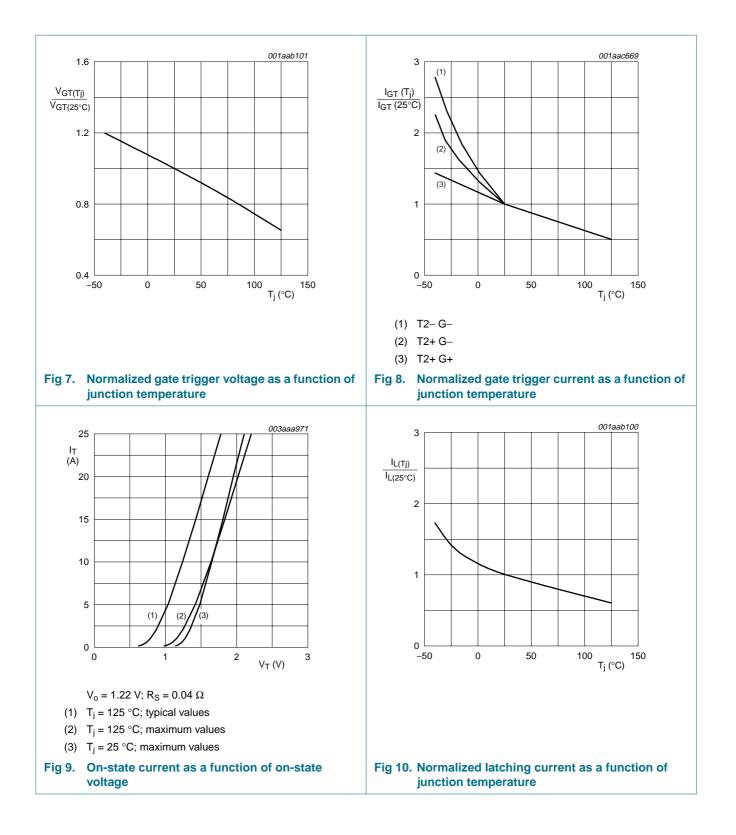
Table 6:	Characteristics
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
-	racteristics					
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ see Figure 8}$	1]			
		T2+ G+	2	6	35	mA
		T2+ G-	2	13	35	mA
		T2– G–	2	23	35	mA
IL	latching current	V _D = 12 V; I _{GT} = 0.1 A; see <u>Figure 10</u>				
		T2+ G+	-	25	50	mA
		T2+ G-	-	48	75	mA
		T2– G–	-	30	50	mA
I _H	holding current	V _D = 12 V; I _{GT} = 0.1 A; see Figure 11	-	20	50	mA
V _T	on-state voltage	I _T = 10 A; see <u>Figure 9</u>	-	1.3	1.65	V
V _{GT}	gate trigger voltage	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 7}}{\text{Figure 7}}$	-	0.7	1.5	V
		$V_D = 400 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T}_j = 125 \ ^\circ\text{C}$	0.25	0.4	-	V
I _D	off-state current	$V_D = V_{DRM(max)}$; $T_j = 125 \ ^{\circ}C$	-	0.1	0.5	mA
Dynamic o	characteristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 67 % $V_{DRM(max)}$; T _j = 125 °C; exponential waveform; gate open circuit	1000	4000	-	V/µs
dl _{com} /dt	rate of change of commutating current	$V_{DM} = 400 \text{ V}; \text{ T}_{j} = 125 \text{ °C};$ $I_{T(RMS)} = 8 \text{ A};$ without snubber; gate open circuit; see Figure 12	12	32	-	A/ms
t _{gt}	gate-controlled turn-on time	$I_{TM} = 12 \text{ A}; V_D = V_{DRM(max)};$ $I_G = 0.1 \text{ A}; dI_G/dt = 5 \text{ A}/\mu \text{s}$	-	2	-	μs

[1] Device will not trigger in the T2– G+ quadrant.

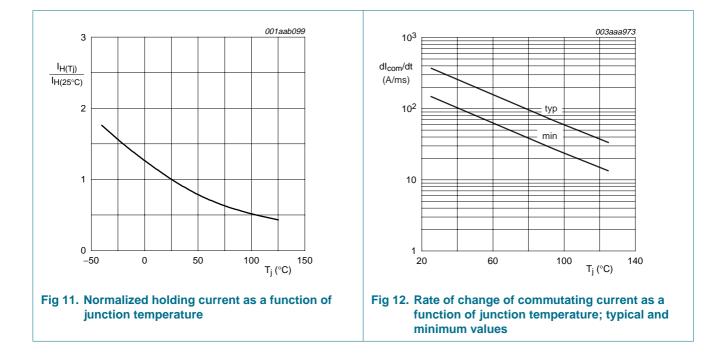
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8. Package outline

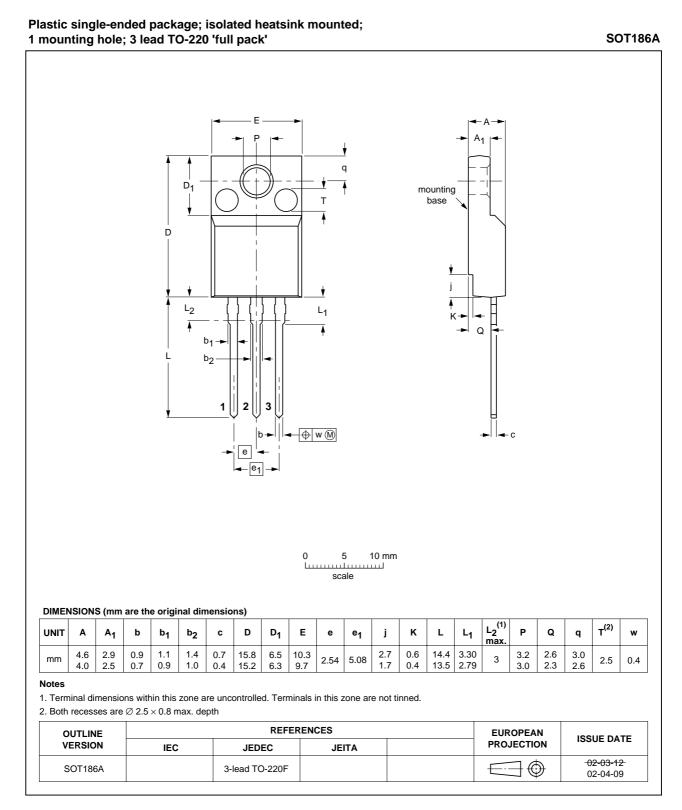


Fig 13. Package outline SOT186A (3-lead TO-220F)

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9. Revision history

Table 7: Revision history					
Document ID	Release date	Data sheet status	Change notice	Doc. number	Supersedes
BTA208X-1000C_1	20051004	Product data sheet	-	-	-

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10. Data sheet status

Level	Data sheet status [1]	Product status [2] [3]	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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